

ABSTRACT OF THE DISCLOSURE

There is disclosed a conductive resin film comprising a conductive substrate layer and a low-resistance layer with a volume resistance of 0.1 to 1.0  $\Omega\text{cm}$  including a fine carbon fiber and a resin in a thickness direction on at least one of its outermost layer. This film exhibits good conductivity even with a low mixing rate of the conductive material and good acid resistance.